



2.0A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER

Product Summary

| | V _{RRM} (V) I _O (A) | | V _{F(MAX)} (V) @+25°C | I _{R(MAX)} (μA) @+25°C | | |
|---|---|-----|--------------------------------|---------------------------------|--|--|
| ı | 100 | 2.0 | 0.86 | 1 | | |

Description and Applications

The device is a single rectifier packaged in PowerDI123. Offering low V_F and excellent high temperature stability this device is ideal for use in general rectification applications as a:

- Boost Diode
- Reverse Protection Diode
- Blocking Diode

Features and Benefits

- Low Forward Voltage (V_F) Minimizes Conduction Losses and Improving Efficiency
- Reduced High Temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation
- Patented Interlocking Clip Design for High Surge Current Capacity
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive–Compliant Part is Available Under Separate Datasheet (<u>DFLS2100Q</u>)

Mechanical Data

- Case: PowerDI123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (2)
- Weight: 0.01 grams (Approximate)

PowerDI123



Top View

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|------------|------------------|
| DFLS2100-7 | PowerDI123 | 3000/Tape & Reel |

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



F09A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

| Year | 2016 | 2017 | 2018 | 2019 | 202 | 0 20 | 21 | 2022 | 2023 | 2024 | 2025 | 2026 |
|-------|------|------|------|------|-----|------|-----|------|-------|------|------|------|
| Code | D | Е | F | G | Н | | I | J | K | L | М | N |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | ј Ѕер | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

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Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|---|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RM} V _{RWM} V _R | 100 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 71 | V |
| Average Rectified Output Current | lo | 2.0 | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 50 | А |

Thermal Characteristics

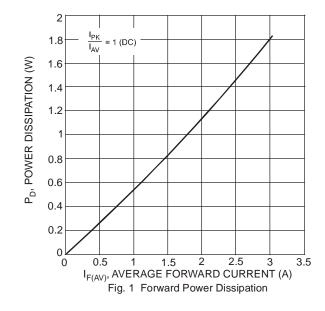
| Characteristic | Symbol | Тур | Max | Unit |
|--|-----------------------------------|--------|------|------|
| Thermal Resistance Junction to Soldering (Note 5) | $R_{	heta JS}$ | _ | 7 | °C/W |
| Thermal Resistance Junction to Ambient (Note 6) (T _A = +25°C) | $R_{\theta JA}$ | 125 | _ | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to | +175 | °C |

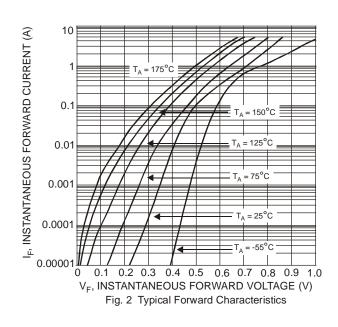
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|----------------|-----|-----|--------------|----------|--|
| Reverse Breakdown Voltage (Note 7) | $V_{(BR)R}$ | 100 | | | V | $I_R = 1\mu A$ |
| Forward Voltage | V _F | | _ | 0.77 0.86 | · · · // | I _F = 1.0A I _F = 2.0A |
| Leakage Current (Note 7) | I _R | | | 1 | μΑ | $V_R = 100V$ |
| Total Capacitance | C_{T} | | 36 | | рF | $V_R = 5VDC$, $f = 1MHz$ |

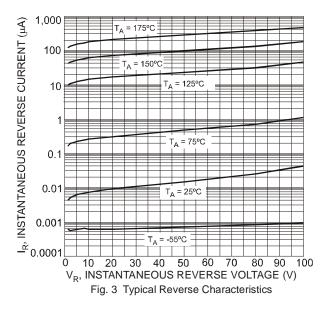
Notes:

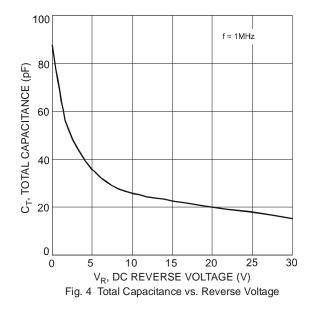
- 5. Theoretical $R_{\theta JS}$ calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
- Part mounted on FR-4 board with 2 oz., minimum recommended copper pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.

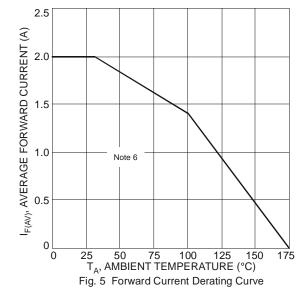










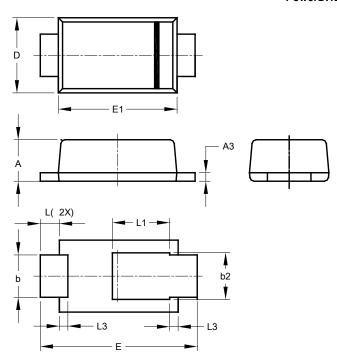




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123

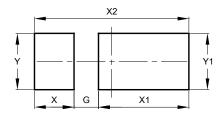


| PowerDI123 | | | | | | | |
|----------------------|-------|-------|------|--|--|--|--|
| Dim Min Max Typ | | | | | | | |
| Α | 0.93 | 1.00 | 0.98 | | | | |
| A3 | 0.15 | 0.25 | 0.20 | | | | |
| b | 0.85 | 1.25 | 1.00 | | | | |
| b2 | 1.025 | 1.125 | 1.10 | | | | |
| D | 1.63 | 1.93 | 1.78 | | | | |
| Е | 3.50 | 3.90 | 3.70 | | | | |
| E1 | 2.60 | 3.00 | 2.80 | | | | |
| L | 0.40 | 0.50 | 0.45 | | | | |
| L1 | 1.25 | 1.40 | 1.35 | | | | |
| L3 | 0.125 | 0.275 | 0.20 | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

PowerDI123



| Dimensions | Value (in mm) | | | | |
|------------|------------------|--|--|--|--|
| G | 0.65 | | | | |
| Х | 1.05 | | | | |
| X1 | 2.40 | | | | |
| X2 | 4.10 | | | | |
| Y | 1.50 | | | | |
| Y1 | 1.50 | | | | |



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